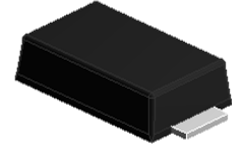


Features

- Total power dissipation: max, 2.0W
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260 °C, 10 s
- Low profile, typical thickness 1.0mm
- For use in stabilizing and clipping circuits with high power rating



RoHS
COMPLIANT



(SMAF)

Maximum Ratings and Thermal Characteristics

(TA = 25 °C unless otherwise noted)

Parameter	Symbol	Value	Unit
Zener current		See Next Table	
Power dissipation at Tamb=50°C	Ptot	2.0	W
Maximum instantaneous forward voltage at 200mA	V _F	1.2	V
Thermal resistance junction to ambient air	Rthja	85	°C/W
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +175	°C

Note1: Thermal resistance from junction to mount, mounted on PCB with 8.0×8.0mm copper pads

Electrical Characteristics (TA = 25 °C unless otherwise noted)

Part Number	Zener voltage		Test current	Dynamic impedance	Knee current	Knee impedance	Reverse current	Reverse voltage	Max.DC current
	V _Z /V		I _{ZT}	Z _{ZT}	I _{ZK}	Z _{ZK}	I _R (Max)	V _R	I _{ZM}
	V _Z (MIN)	V _Z (MAX)	m A	Ω	m A	Ω	μA _{dc}	V	m A
L2N5923B	7.79	8.61	45.7	3.5	0.5	400	5	6.5	182
L2N5924B	8.65	9.56	41.2	4	0.5	500	5	7	164
L2N5925B	9.5	10.5	37.5	4.5	0.25	500	5	8	150
L2N5926B	10.45	11.55	34.1	5.5	0.25	550	1	8.4	136
L2N5927B	11.4	12.6	31.2	6.5	0.25	550	1	9.1	125
L2N5928B	12.35	13.65	28.8	7	0.25	550	1	9.9	115

Electrical Characteristics (TA = 25 °C unless otherwise noted)									
Part Number	Zener voltage		Test current	Dynamic impedance	Knee current	Knee impedance	Reverse current	Reverse voltage	Max.DC current
	VZ /V		IZT	ZZT	IZK	ZZK	IR(Max)	VR	IZM
	Vz(MIN)	Vz(MAX)	m A	Ω	m A	Ω	μAdc	V	m A
L2N5929B	14.25	15.75	25	9	0.25	600	1	11.4	100
L2N5930B	15.2	16.8	23.4	10	0.25	600	1	12.2	93
L2N5931B	17.1	18.9	20.8	12	0.25	650	1	13.7	83
L2N5932B	19	21	18.7	14	0.25	650	1	15.2	75
L2N5933B	20.9	23.1	17	17.5	0.25	650	1	16.7	68
L2N5934B	22.8	25.2	15.6	19	0.25	700	1	18.2	62
L2N5935B	25.65	28.35	13.9	23	0.25	700	1	20.6	55
L2N5936B	28.5	31.5	12.5	28	0.25	750	1	22.8	50
L2N5937B	31.35	34.65	11.4	33	0.25	800	1	25.1	45
L2N5938B	34.2	37.8	10.4	38	0.25	850	1	27.4	41
L2N5939B	37.05	40.95	9.6	45	0.25	900	1	29.7	38
L2N5940B	40.85	45.15	8.7	53	0.25	950	1	32.7	34
L2N5941B	44.65	49.35	8	67	0.25	1000	1	35.8	31
L2N5942B	48.45	53.55	7.3	70	0.25	1100	1	38.8	29
L2N5943B	53.2	58.8	6.7	86	0.25	1300	1	42.6	26
L2N5944B	58.9	65.1	6	100	0.25	1500	1	47.1	24
L2N5945B	64.6	71.4	5.5	120	0.25	1700	1	51.7	22
L2N5946B	71.25	78.8	5	140	0.25	2000	1	56	20
L2N5947B	77.9	86.1	4.6	160	0.25	2500	1	62.2	18
L2N5948B	86.45	95.6	4.1	200	0.25	3000	1	69.2	16
L2N5949B	95	105	3.7	250	0.25	3100	1	76	20
L2N5950B	104.5	115.5	3.4	300	0.25	4000	1	83.6	13
L2N5951B	114	126	3.1	380	0.25	4500	1	91.2	12
L2N5952B	123.5	136.5	2.9	450	0.25	5000	1	98.8	11
L2N5953B	142.5	157.5	2.5	600	0.25	6000	1	114	10
L2N5954B	152	168	2.3	700	0.25	6500	1	121.6	9
L2N5955B	171	189	2.1	900	0.25	7000	1	136.8	8
L2N5956B	190	210	1.9	1200	0.25	8000	1	152	7

Ratings and Characteristics Curves

(T_A = 25°C unless otherwise noted)

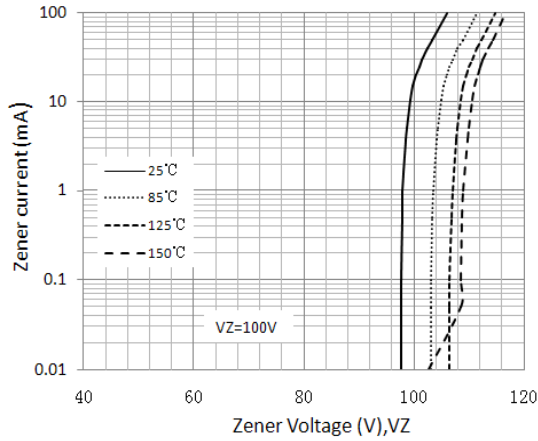


Figure 1. Typical Zener Voltage

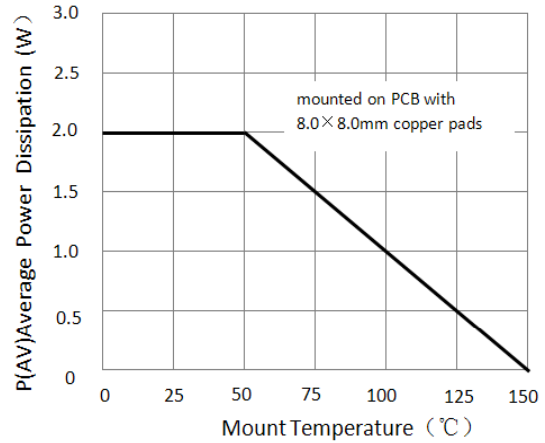


Figure 2. Steady State POWER Derating

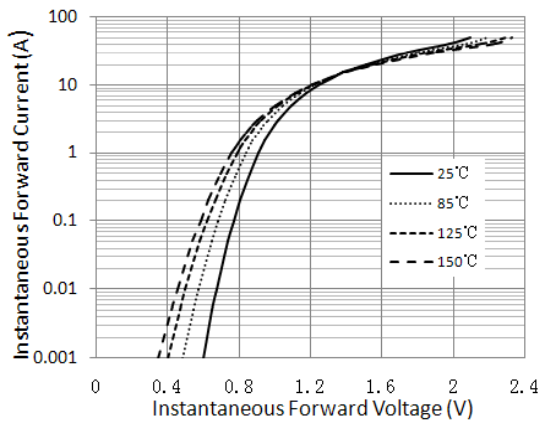


Figure 3. Typical Instantaneous Forward Characteristics

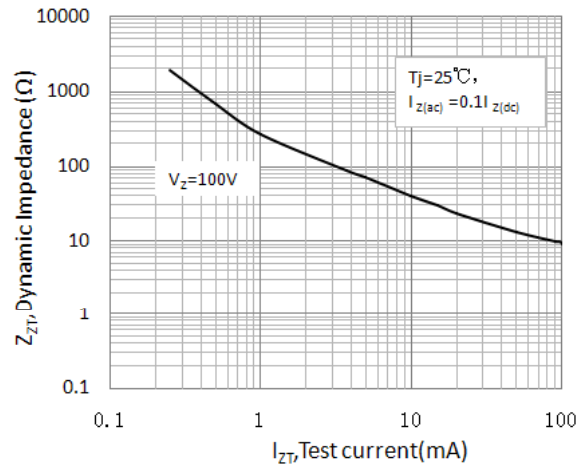


Figure 4. Typical Zener Impedance

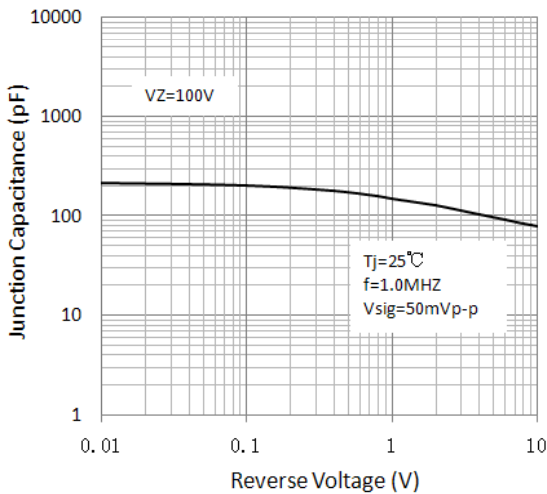
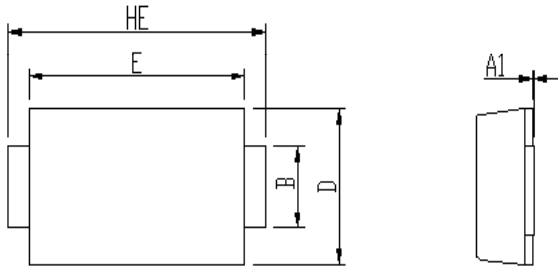


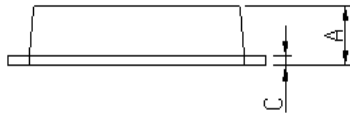
Figure 5. Typical Junction Capacitance

Package Outline Dimensions

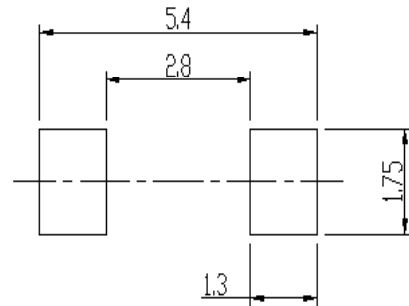
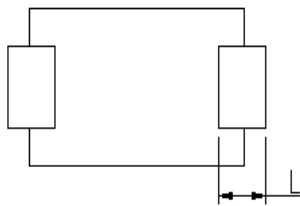
in inches (millimeters)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.9	1.08	0.035	0.043
A1	0	0.1	0.000	0.004
B	1.25	1.45	0.049	0.057
C	0.1	0.25	0.004	0.010
D	2.6	2.8	0.102	0.110
E	4.1	4.3	0.161	0.169
L	0.7	1.1	0.028	0.043
HE	4.8	5.2	0.189	0.205



Soldering footprint



Packing Information

Packing quantities:

10,000 pcs/Reel, 12mm Tape, 13" Reel

Tape & Reel Specification

